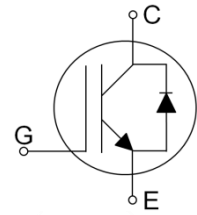


### Features

- 650V Field Stop Trench IGBT Technology
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy Parallel Operation
- 175°C Operating Temperature
- Short Circuit Withstanding Time 5μs
- RoHS Compliant
- JEDEC Qualification

TO-247



### Applications

UPS, Welder, Inverter, Solar

Device	Package	Marking	Remark
TGH40N65F2DR	TO-247	TGH40N65F2DR	RoHS

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-Emitter Voltage	$V_{CES}$	650	V	
Gate-Emitter Voltage	$V_{GES}$	±20	V	
Continuous Collector Current	$I_C$	$T_C = 25\text{ }^\circ\text{C}$	80	A
		$T_C = 100\text{ }^\circ\text{C}$	40	A
Pulsed Collector Current (Note 1)	$I_{CM}$	120	A	
Diode Continuous Forward Current	$I_F$	40	A	
Diode Pulsed Current (Note 2)	$I_{FM}$	200	A	
Power Dissipation	$P_D$	$T_C = 25\text{ }^\circ\text{C}$	283	W
		$T_C = 100\text{ }^\circ\text{C}$	142	W
Operating Junction Temperature	$T_{vj}$	-55 ~ 175	°C	
Storage Temperature Range	$T_{STG}$	-55 ~ 150	°C	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300	°C	

- Notes :
- (1) Repetitive rating : Pulse width limited by maximum junction temperature. During production, high current switching capability is 100% verified with the inductive load single-pulse switching test. ( $I_C=120A$ )
  - (2) Repetitive rating : Pulse width limited by maximum junction temperature.

### Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.53	°C/W
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	1.43	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

### Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$ , unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
<b>OFF</b>						
Collector – Emitter Breakdown Voltage	$BV_{CES}$	$V_{GE} = 0V, I_C = 1mA$	650	--	--	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 650V, V_{GE} = 0V$	--	--	1	mA
Gate – Emitter Leakage Current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = \pm 20V$	--	--	$\pm 250$	nA
Integrated Gate Resistance	$R_{G(int)}$	$f = 1MHz, \text{Open Collector}$	--	3.9	--	$\Omega$
<b>ON</b>						
Gate – Emitter Threshold Voltage	$V_{GE(TH)}$	$V_{GE} = V_{CE}, I_C = 40mA$	4.5	6.0	7.5	V
Collector – Emitter Saturation Voltage	$V_{CE(SAT)}$	$V_{GE} = 15V, I_C = 40A, T_{vj} = 25^{\circ}\text{C}$	--	1.60	2.10	V
		$V_{GE} = 15V, I_C = 40A, T_{vj} = 125^{\circ}\text{C}$	--	1.81	--	V
		$V_{GE} = 15V, I_C = 40A, T_{vj} = 175^{\circ}\text{C}$	--	1.94	--	V
<b>DYNAMIC</b>						
Input Capacitance	$C_{IES}$	$V_{CE} = 30V$ $V_{GE} = 0V$ $f = 1MHz$	--	2274	--	pF
Output Capacitance	$C_{OES}$		--	114	--	pF
Reverse Transfer Capacitance	$C_{RES}$		--	72	--	pF
Total Gate Charge	$Q_g$	$V_{CC} = 400V, I_C = 40A$ $V_{GE} = 15V$	--	121	182	nC
Gate-Emitter Charge	$Q_{ge}$		--	15	22	nC
Gate-Collector Charge	$Q_{gc}$		--	59	89	nC
<b>SWITCHING</b> (Note 3)						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 400V, I_C = 20A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^{\circ}\text{C}$	--	25	--	ns
Rise Time	$t_r$		--	18	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	126	--	ns
Fall Time	$t_f$		--	34	--	ns
Turn-On Switching Loss	$E_{ON}$		--	0.36	--	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	0.26	--	mJ
Total Switching Loss	$E_{TS}$	--	0.62	--	mJ	
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 400V, I_C = 40A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^{\circ}\text{C}$	--	28	--	ns
Rise Time	$t_r$		--	29	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	108	--	ns
Fall Time	$t_f$		--	37	--	ns
Turn-On Switching Loss	$E_{ON}$		--	1.06	1.59	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	0.55	0.83	mJ
Total Switching Loss	$E_{TS}$	--	1.61	2.42	mJ	

### Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$ , unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
<b>SWITCHING</b> (Note 3)						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 400\text{V}, I_C = 20\text{A}$ $R_G = 5\Omega, V_{GE} = 15\text{V}$ Inductive Load, $T_{vj} = 175^{\circ}\text{C}$	--	23	--	ns
Rise Time	$t_r$		--	16	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	166	--	ns
Fall Time	$t_f$		--	115	--	ns
Turn-On Switching Loss	$E_{ON}$		--	0.74	--	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	0.59	--	mJ
Total Switching Loss	$E_{TS}$		--	1.33	--	mJ
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 400\text{V}, I_C = 40\text{A}$ $R_G = 5\Omega, V_{GE} = 15\text{V}$ Inductive Load, $T_{vj} = 175^{\circ}\text{C}$	--	27	--	ns
Rise Time	$t_r$		--	32	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	137	--	ns
Fall Time	$t_f$		--	101	--	ns
Turn-On Switching Loss	$E_{ON}$		--	1.66	2.48	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	1.01	1.52	mJ
Total Switching Loss	$E_{TS}$		--	2.67	4.00	mJ
Short Circuit Withstanding Time	$t_{SC}$	$V_{CC} = 300\text{V}, V_{GE} = 15\text{V}, T_{vj} = 125^{\circ}\text{C}$	5	--	--	$\mu\text{s}$

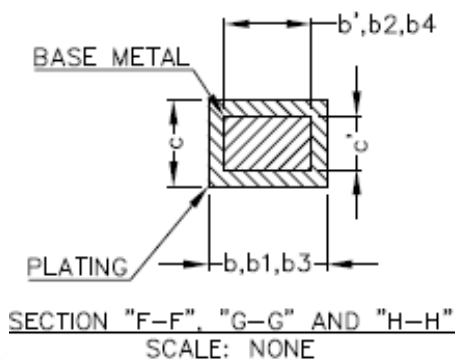
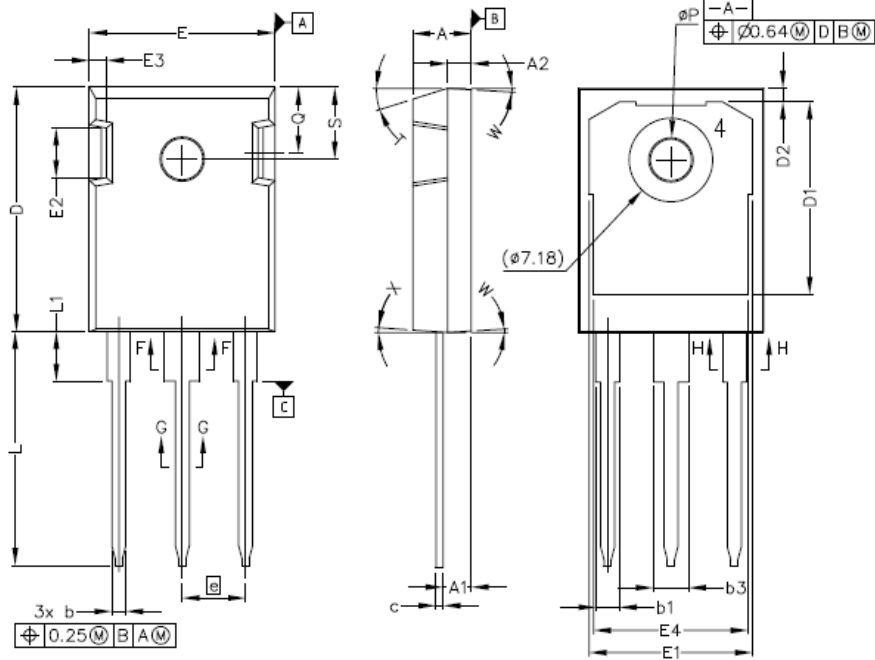
Notes :

(3) Not subject to production test – verified by design/characterization

**Electrical Characteristics of the DIODE  $T_{vj}=25^{\circ}\text{C}$ , unless otherwise noted**

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
Diode Forward Voltage	$V_{FM}$	$I_F = 20\text{A}, T_{vj} = 25^{\circ}\text{C}$	--	1.70	--	V
		$I_F = 20\text{A}, T_{vj} = 125^{\circ}\text{C}$	--	1.54	--	V
		$I_F = 20\text{A}, T_{vj} = 175^{\circ}\text{C}$	--	1.41	--	V
		$I_F = 40\text{A}, T_{vj} = 25^{\circ}\text{C}$	--	2.10	--	V
		$I_F = 40\text{A}, T_{vj} = 125^{\circ}\text{C}$	--	2.03	--	V
		$I_F = 40\text{A}, T_{vj} = 175^{\circ}\text{C}$	--	1.94	--	V
Reverse Recovery Time	$t_{rr}$	$I_F = 20\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 25^{\circ}\text{C}$	--	99	--	ns
Reverse Recovery Current	$I_{rr}$		--	5.6	--	A
Reverse Recovery Charge	$Q_{rr}$		--	256	--	nC
Reverse Recovery Time	$t_{rr}$	$I_F = 20\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 175^{\circ}\text{C}$	--	163	--	ns
Reverse Recovery Current	$I_{rr}$		--	12.6	--	A
Reverse Recovery Charge	$Q_{rr}$		--	1266	--	nC
Reverse Recovery Time	$t_{rr}$	$I_F = 40\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 25^{\circ}\text{C}$	--	113	--	ns
Reverse Recovery Current	$I_{rr}$		--	5.9	--	A
Reverse Recovery Charge	$Q_{rr}$		--	322	--	nC
Reverse Recovery Time	$t_{rr}$	$I_F = 40\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 175^{\circ}\text{C}$	--	201	--	ns
Reverse Recovery Current	$I_{rr}$		--	13.3	--	A
Reverse Recovery Charge	$Q_{rr}$		--	1660	--	nC

### TO-247 MECHANICAL DATA



SYM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	.190	.205
A1	2.29	2.54	.090	.100
A2	1.91	2.16	.075	.085
b'	1.07	1.28	.042	.050
b	1.07	1.33	.042	.052
b1	1.91	2.41	.075	.095
b2	1.91	2.16	.075	.085
b3	2.87	3.38	.113	.133
b4	2.87	3.13	.113	.123
c'	0.55	0.65	.022	.026
c	0.55	0.68	.022	.027
D	20.80	21.10	.819	.831
D1	16.25	17.65	.640	.695
D2	0.95	1.25	.037	.049
E	15.75	16.13	.620	.635
E1	13.10	14.15	.516	.557
E2	3.68	5.10	.145	.201
E3	1.00	1.90	.039	.075
E4	12.38	13.43	.487	.529
e	5.44 BSC		.214 BSC	
N	3		3	
L	19.81	20.32	.780	.800
L1	4.10	4.40	.161	.173
φP	3.51	3.65	.138	.144
Q	5.49	6.00	.216	.236
S	6.04	6.30	.238	.248
T	17.5° REF.			
W	3.5° REF.			
X	4° REF.			

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